

### *Dimensions*

Size: 26 x 13 mils

Thickness: 5 mils

Bond Pad Size: 5 x 8 mils

### *Features*

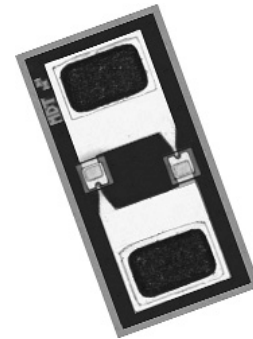
- Capacitance (65 fF Typ.)
- Low Series Resistance (3  $\Omega$  Typ.)
- Cut-Off Frequency > 500 GHz
- Large Gold Bond Pads

### *Specifications @ 25°C* *(Per Junction)*

- $V_F$  (1 mA): 650–750 mV
- $\Delta V_F$  (1 mA): 10 mV Max.
- $R_S$  (10 mA): 7  $\Omega$  Max.
- $I_R$  (3 V): 10  $\mu$ A Max.
- $C_T$  (0 V): 80 fF Max.

### *Maximum Ratings*

Insertion Temperature	250°C for 10 Seconds
Incident Power	+20 dBm @ 25°C
Forward Current	15 mA @ 25°C
Reverse Voltage	3 V
Operating Temperature	-55°C to +125°C
Storage Temperature	-65°C to +150°C

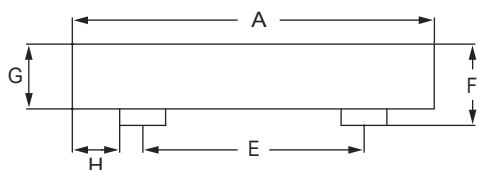
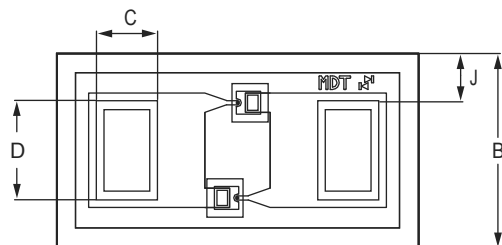
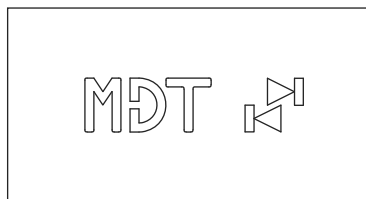


### *Description*

The MS8250 is a GaAs flip chip anti-parallel pair Schottky device designed for use as harmonic mixer elements at microwave and millimeter wave frequencies. Their high cut-off frequency insures good performance at frequencies to 100 GHz. Applications include: transceivers, digital radios and automotive radar detectors.

These flip chip devices incorporate Microsemi's expertise in GaAs material processing, silicon nitride protective coatings and high temperature metallization. They have large, 5 x 8 mil, bond pads for ease of insertion. The MS8250 is priced for high volume commercial and industrial applications.

P2613



DIM	INCHES		MM	
	MIN.	MAX.	MIN.	MAX.
A	0.0255	0.0265	0.6480	0.6730
B	0.0125	0.0135	0.3180	0.3430
C	0.0046	0.0056	0.1170	0.1420
D	0.0075	0.0085	0.1910	0.2160
E	0.0170	0.0180	0.4320	0.4570
F	0.0050	0.0060	0.1270	0.1520
G	0.0045	0.0055	0.1140	0.1400
H	0.0016	0.0020	0.0406	0.0508
J	0.0023	0.0027	0.0584	0.0686

### Spice Model Parameters (Per Junction)

$I_s$	$R_s$	N	TT	$C_{j0}$	$C_p$	M	EG	$V_j$	BV	IBV
A	$\Omega$		Sec	pF	pF		eV	V	V	A
$3.2 \times 10^{-13}$	3	1	0	0.45	0.02	0.50	1.42	0.85	4	$1 \times 10^{-5}$

**IMPORTANT:** For the most current data, consult our website: [www.MICROSEMI.com](http://www.MICROSEMI.com)  
 Specifications are subject to change. Consult factory for the latest information.



These devices are ESD sensitive and must be handled using ESD precautions.

<sup>1</sup> The MS8250 is supplied with a RoHS complaint Gold finish.